## **Application Data Sheet**

#### **Application Information**

Application Type::

Regular

Subject Matter::

Utility

Suggested Classification::

Suggested Group Art Unit::

CD-ROM or CD\_R?::

None

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

No

Computer Readable Form (CRF)?::

No

Title::

METHOD OF MANUFACTURING SEMICONDUCTOR

**DEVICE** 

Attorney Docket Number::

12844.45US01

Request For Early Publication::

No

Request For Non-Publication::

No

Suggested Drawing Figure::

**Total Drawing Sheets:** 

7

Small Entity::

No

Latin Name::

Variety Denomination Name::

Petition Included::

No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?::

No

#### **Applicant Information**

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Status::

**Full Capacity** 

Given Name::

Suguru

Middle Name::

Family Name::

**TABARA** 

Name Suffix::

City of Residence::

Hamamatsu-shi

State or Province of Residence::

Country of Residence::

Japan

Street of mailing address::

c/o Rohm Hammamatsu Co., Ltd., 10 Sanwa-cho

City of mailing address::

Hamamatsu-shi

State or Province of mailing address::

Shizuoka

Country of mailing address::

Japan

Postal or Zip Code of mailing address:: 435-0038

### Correspondence Information

Correspondence Customer Number::

23552

### Representative Information

Representative Customer Number::	23552
Representative Customer Number::	23552

## Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-296478	10/09/02	Yes

# **Assignee Information**

Assignee Name::

Rohm Co., Ltd.

Street of mailing address::

21, Saiin Mizosaki-cho, Ukyo-ku

City of mailing address::

Kyoto-shi

State or Province of mailing address::

**Kyoto** 

Country of mailing address::

Japan

Postal or Zip Code of mailing address:: 615-8585